PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MICHAEL P. BAUERLY	09/12/2014
BRIAN W. JOHNSON	09/15/2014
REIKO MIYAZAKI	09/11/2014
TATSUSHI NASHIDA	09/11/2014
KEN MIYASHITA	09/11/2014

RECEIVING PARTY DATA

Name:	Sony Corporation
Street Address:	1-7-1 Konan
Internal Address:	Minato-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	108-0075

PROPERTY NUMBERS Total: 2

Property Type	Number
Application Number:	13077972
Application Number:	61404274

CORRESPONDENCE DATA

Fax Number: (408)738-0881

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (408) 738-0592

Email: efiling@ishimarulaw.com

Correspondent Name: MIKIO ISHIMARU

Address Line 1: ISHIMARU & ASSOCIATES LLP
Address Line 2: 2055 GATEWAY PLACE, SUITE 700
Address Line 4: SAN JOSE, CALIFORNIA 95110

ATTORNEY DOCKET NUMBER:	1014-045 / 201003549.02
NAME OF SUBMITTER:	MIKIO ISHIMARU
SIGNATURE:	/Mikio Ishimaru/
DATE SIGNED:	12/31/2014

503120249 PATENT REEL: 034606 FRAME: 0076

Total Attachments: 7 source=1014-045_Assignment#page1.tif source=1014-045_Assignment#page2.tif source=1014-045_Assignment#page3.tif source=1014-045_Assignment#page4.tif source=1014-045_Assignment#page5.tif source=1014-045_Assignment#page6.tif source=1014-045_Assignment#page7.tif

PATENT REEL: 034606 FRAME: 0077

ASSIGNMENT

WHEREAS, I, as a below named inventor, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

ELECTRONIC DEVICE SYSTEM WITH PROCESS CONTINUATION MECHANISM AND METHOD OF OPERATION THEREOF

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan, 108-0075 (hereinafter referenced as ASSIGNEE(S)) is desirous of securing all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefore in the United States and in any and all foreign countries;

NOW THEREFORE, in return for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and any foreign countries, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America or any foreign country adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and foreign countries, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the assignees of the whole right, title and interest thereto;

I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or its designee, as ASSIGNEES or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and foreign countries;

I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEES thereof shall hereafter require and prepare at their own expense;

I further agree that ASSIGNEES will, upon their request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with or impact in any way this assignment and sale;

I further agree that this Assignment shall be deemed to have been made and executed in the State of Delaware and any dispute arising hereunder not governed by US federal law will be resolved in accordance with the laws of the State of Delaware without reference to its conflict of law principles. I hereby consent and submit to the jurisdiction of the federal and state courts located in the State of Delaware. Any action or suit under this Agreement or otherwise arising from the relationship between the parties will only be brought in any federal or state court with appropriate jurisdiction over the subject matter hereof sitting in the State of Delaware. I WILL NOT RAISE IN CONNECTION HEREWITH, AND HEREBY WAIVE, TRIAL BY JURY AND/OR ANY DEFENSES BASED UPON THE VENUE, THE INCONVENIENCE OF THE FORUM, THE LACK OF PERSONAL JURISDICTION, THE SUFFICIENCY OF SERVICE OF PROCESS OR THE LIKE IN ANY ACTION OR SUIT ARISING FROM SUCH DISPUTE;

1

Docket No. 1014-045 ASSIGNMENT

I agree that all my obligations hereunder shall survive any termination of my employment and shall be binding on my heirs, executors, administrators, or other legal representatives or assigns;

And I hereby authorize and request my attorney(s) of record in this application to insert the execution date, serial number and filing date of this Non Provisional application and that of the Provisional application from which it claims priority in the spaces that follow:

Serial Number: 13/077,972 Filing Date: March 31, 2011

Serial Number: 61/404,274 Filing Date: September 29, 2010.

This assignment	t is executed on the date indicated be	HOW.	
2. MICHAEL F	P. BAUERLY		2/2014
State of	ss		
On	before me,	ame and title of officer)	
whose name(s) is subsci in his/her authorized cap	chael P. Bauerly, proved to me on the ribed to the within instrument and ac- pacity(ies), and that by his/her signation person(s) acted, executed the instru	knowledged to me that he/she ures on the instrument the pers	executed the same
-	PENALTY OF PERJURY under the		that the
WITNESS my h	nand and official seal.		
Signature			

Docket No. 1014-045

This assignment is executed on the date indicated below.

4. BRIANW. JOH	HNSON	Dated: 2014.9	15
State of	 ss		
-	before me,(nam	a and title of officer)	1
personally appeared Brian V whose name(s) is subscribe in his/her authorized capacit	W. Johnson, proved to me on the bard to the within instrument and acknuty(les), and that by his/her signature rson(s) acted, executed the instrum	asis of satisfactory evidence to nowledged to me that he/she ex es on the instrument the persor	ecuted the same
I certify under PE foregoing paragraph is true	NALTY OF PERJURY under the and correct.	law of the State of	that the
WITNESS my hand	d and official seal.		
Signature			

This assignment is being executed on the date indicated below.

Reiko Miyazaki 5. REIKO MIYAZAKI

Dated: 5ep 11. 2014

7

This assignment is being executed on the date indicated below.

lateus li Nashida
6. Tatsushi Nashida

Dated: Sep 11, 2014

8

This assignment is being executed on the date indicated below.

Ken My ashite
7. KEN MIYASHITA

Dated: September 11, 2014

9

PATENT REEL: 034606 FRAME: 0084